

Features

- 0.3 ps RMS phase jitter (random) for 10GbE applications
- Frequency stability as low as ±10 ppm
- 100% drop-in replacement for quartz and SAW oscillators
- Configurable positive frequency shift, +25, +50, or +75 ppm
- Industry-standard packages: 3.2 x 2.5, 5.0 x 3.2, 7.0 x 5.0 mmxmm
- Industrial and extended commercial temperature ranges
- Best in class 1-year and 10-year aging
- Best resilience, up to 40x better than quartz
- For other frequencies, refer to SiT9121 or 9122 datasheet

Electrical Characteristics

Applications

- 10GB Ethernet, SONET, SATA, SAS, Fibre Channel, PCI-Express
- Telecom, networking, instrumentation, storage, servers



| Electrical Character | 151105 | | | | | | | |
|-----------------------------------|-----------|----------|---|-----------|------------|---|--|--|
| Parameter and Conditions | Symbol | Min. | Тур. | Max. | Unit | Condition | | |
| | L | VPECL an | d LVDS, C | ommon El | ectrical C | Characteristics | | |
| Supply Voltage | Vdd | 2.97 | 3.3 | 3.63 | V | | | |
| | | 2.25 | 2.5 | 2.75 | V | | | |
| | | 2.25 | - | 3.63 | V | Termination schemes in Figures 1 and 2 - XX ordering code | | |
| Output Frequency Range | f | 156.25 | 5000, 156.25 7812, 156.2 161.132800 | 61718, | MHz | 156.253906 MHz, +25 PPM from 156.250000 156.257812 MHz, +50 PPM from 156.250000 156.261718 MHz, +75 PPM from 156.250000 | | |
| Frequency Stability | F_stab | -10 | - | +10 | ppm | | | |
| | | -20 | - | +20 | ppm | Inclusive of initial tolerance, operating temperature, rated power | | |
| | | -25 | - | +25 | ppm | supply voltage, and load variations | | |
| | | -50 | - | +50 | ppm | | | |
| First Year Aging | F_aging1 | -2 | - | +2 | ppm | 25°C | | |
| 10-year Aging | F_aging10 | -5 | - | +5 | ppm | 25°C | | |
| Operating Temperature Range | T_use | -40 | - | +85 | °C | Industrial | | |
| | | -20 | - | +70 | °C | Extended Commercial | | |
| Input Voltage High | VIH | 70% | - | - | Vdd | Pin 1, OE or ST | | |
| Input Voltage Low | VIL | - | - | 30% | Vdd | Pin 1, OE or ST | | |
| Input Pull-up Impedance | Z_in | - | 100 | 250 | kΩ | Pin 1, OE logic high or logic low, or ST logic high | | |
| | | 2 | - | - | MΩ | Pin 1, ST logic low | | |
| Start-up Time | T_start | - | 6 | 10 | ms | Measured from the time Vdd reaches its rated minimum value. | | |
| Resume Time | T_resume | _ | 6 | 10 | ms | In Standby mode, measured from the time $\overline{\text{ST}}$ pin crosses 50% threshold. | | |
| Duty Cycle | DC | 45 | - | 55 | % | Contact SiTime for tighter duty cycle | | |
| | | LV | /PECL, DO | and AC C | haracter | istics | | |
| Current Consumption | ldd | - | 61 | 69 | mA | Excluding Load Termination Current, Vdd = 3.3V or 2.5V | | |
| OE Disable Supply Current | I_OE | - | - | 35 | mA | OE = Low | | |
| Output Disable Leakage Current | I_leak | - | - | 1 | μA | OE = Low | | |
| Standby Current | I_std | - | - | 100 | μA | ST = Low, for all Vdds | | |
| Maximum Output Current | I_driver | - | - | 30 | mA | Maximum average current drawn from OUT+ or OUT- | | |
| Output High Voltage | VOH | Vdd-1.1 | - | Vdd-0.7 | V | See Figure 1(a) | | |
| Output Low Voltage | VOL | Vdd-1.9 | - | Vdd-1.5 | V | See Figure 1(a) | | |
| Output Differential Voltage Swing | V_Swing | 1.2 | 1.6 | 2.0 | V | See Figure 1(b) | | |
| Rise/Fall Time | Tr, Tf | - | 300 | 500 | ps | 20% to 80%, see Figure 1(a) | | |
| OE Enable/Disable Time | T_oe | - | - | 120 | ns | f = 156.25 MHz - For other frequencies, T_oe = 100ns + 3 period | | |
| RMS Phase Jitter (random) | T_phj | - | 0.25 | 0.3 | ps | IEEE802.3-2005 10GbE jitter measurement specifications | | |
| | | L | VDS, DC | and AC Ch | aracteris | tics | | |
| Current Consumption | ldd | - | 47 | 55 | mA | Excluding Load Termination Current, Vdd = 3.3V or 2.5V | | |
| OE Disable Supply Current | I_OE | - | - | 35 | mA | OE = Low | | |
| Differential Output Voltage | VOD | 250 | 350 | 450 | mV | See Figure 2 | | |

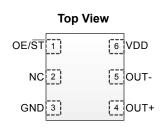
Time

Electrical Characteristics (continued)

| Parameter and Conditions | Symbol | Min. | Тур. | Max. | Unit | Condition | | |
|---|--------|-------|------|-------|------|---|--|--|
| LVDS, DC and AC Characteristics (continued) | | | | | | | | |
| Output Disable Leakage Current | I_leak | - | - | 1 | μA | OE = Low | | |
| Standby Current | I_std | - | - | 100 | μA | ST = Low, for all Vdds | | |
| VOD Magnitude Change | ΔVOD | - | - | 50 | mV | See Figure 2 | | |
| Offset Voltage | VOS | 1.125 | 1.2 | 1.375 | V | See Figure 2 | | |
| VOS Magnitude Change | ΔVOS | - | - | 50 | mV | See Figure 2 | | |
| Rise/Fall Time | Tr, Tf | - | 495 | 600 | ps | 20% to 80%, see Figure 2 | | |
| OE Enable/Disable Time | T_oe | - | - | 115 | ns | f = 156.25 MHz - For other frequencies, T_oe = 100ns + 3 period | | |
| RMS Phase Jitter (random) | T_phj | - | 0.25 | 0.3 | ps | IEEE802.3-2005 10GbE jitter measurement specifications | | |

Pin Description

| Pin | Мар | Functionality | | | | |
|-----|------|---------------|--|--|--|--|
| | OE | Input | H or Open: specified frequency output L: output is high impedance | | | |
| 1 | ST | Input | H or Open: specified frequency output L: Device goes to sleep mode. Supply current reduces to I_std. | | | |
| 2 | NC | NA | No Connect; Leave it floating or connect to GND for better heat dissipation | | | |
| 3 | GND | Power | VDD Power Supply Ground | | | |
| 4 | OUT+ | Output | Oscillator output | | | |
| 5 | OUT- | Output | Complementary oscillator output | | | |
| 6 | VDD | Power | Power supply voltage | | | |



Absolute Maximum

Attempted operation outside the absolute maximum ratings of the part may cause permanent damage to the part. Actual performance of the IC is only guaranteed within the operational specifications, not at absolute maximum ratings.

| Parameter | Min. | Max. | Unit |
|--|------|------|------|
| Storage Temperature | -65 | 150 | °C |
| VDD | -0.5 | 4 | V |
| Electrostatic Discharge (HBM) | - | 2000 | V |
| Soldering Temperature (follow standard Pb free soldering guidelines) | - | 260 | °C |

Thermal Consideration

| Package | θJA, 4 Layer Board (°C/W) | θJC, Bottom (°C/W) |
|-------------|------------------------------|-----------------------|
| 7050, 6-pin | 142 | 27 |
| 5032, 6-pin | 97 | 20 |
| 3225, 6-pin | 109 | 20 |

Environmental Compliance

| Parameter | Condition/Test Method |
|----------------------------|---------------------------|
| Mechanical Shock | MIL-STD-883F, Method 2002 |
| Mechanical Vibration | MIL-STD-883F, Method 2007 |
| Temperature Cycle | JESD22, Method A104 |
| Solderability | MIL-STD-883F, Method 2003 |
| Moisture Sensitivity Level | MSL1 @ 260°C |



Waveform Diagrams

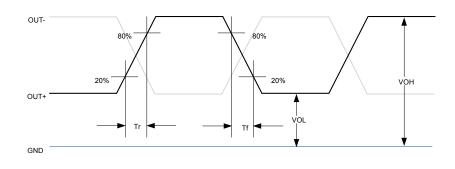


Figure 1(a). LVPECL Voltage Levels per Differential Pin (OUT+/OUT-)

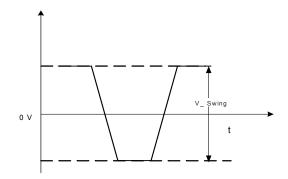


Figure 1(b). LVPECL Voltage Levels Across Differential Pair

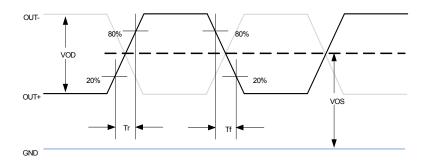


Figure 2. LVDS Voltage Levels per Differential Pin (OUT+/OUT-)

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Termination Diagrams

LVPECL:

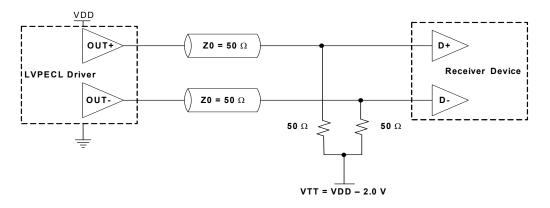


Figure 3. LVPECL Typical Termination

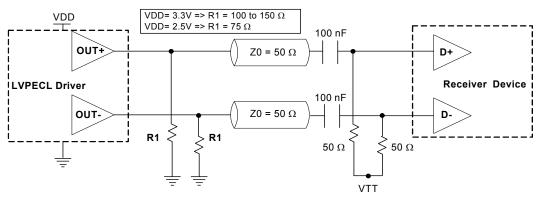


Figure 4. LVPECL AC Coupled Termination

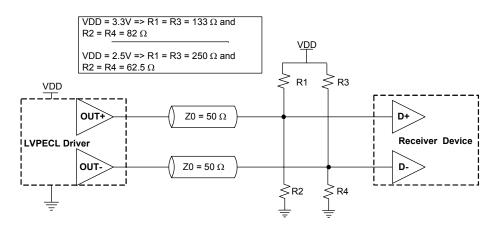


Figure 5. LVPECL with Thevenin Typical Termination

LVDS:

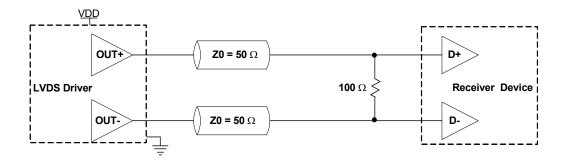


Figure 6. LVDS Single Termination (Load Terminated)

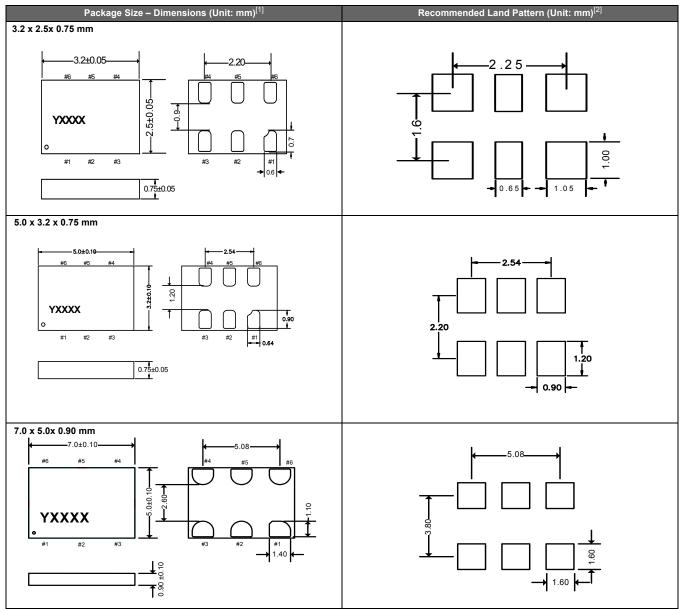
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Dimensions and Patterns

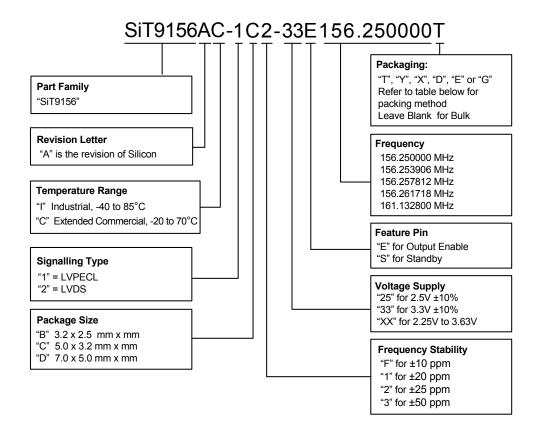


Notes:

1. Top Marking: Y denotes manufacturing origin and XXXX denotes manufacturing lot number. The value of "Y" will depend on the assembly location of the device.

2. A capacitor of value 0.1 μF between Vdd and GND is recommended.

Ordering Information



Ordering Codes for Supported Tape & Reel Packing Method

| Device Size | 8 mm T&R (3ku) | 8 mm T&R (1ku) | 8 mm T&R (250u) | 12 mm T&R (3ku) | 12 mm T&R (1ku) | 12 mm T&R (250u) | 16 mm T&R (3ku) | 16 mm T&R (1ku) | 16 mm T&R (250u) |
|--------------|-------------------|-------------------|--------------------|--------------------|--------------------|---------------------|--------------------|--------------------|---------------------|
| 7.0 x 5.0 mm | - | - | - | - | - | - | Т | Y | Х |
| 5.0 x 3.2 mm | - | - | - | Т | Y | х | - | - | - |
| 3.2 x 2.5 mm | D | E | G | Т | Y | х | - | - | - |

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Revision History

| Version | Release Date | Change Summary |
|---------|--------------|--|
| 1.01 | 2/20/13 | Original |
| 1.02 | 12/3/13 | Added input specifications, LVPECL/LVDS waveforms, packaging T&R options |
| 1.03 | 2/6/14 | Added 8mm T&R option |
| 1.04 | 3/3/14 | Added ±10 ppm |
| 1.05 | 7/23/14 | Include Thermal Consideration Table |
| 1.06 | 10/6/14 | Modified Thermal Consideration values |

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